

Statement of Compliance

Requested Part

(Part 1 of 1)
-2
3 1% 3K92 0.2W
with Exemptions in glass or Ceramic Elec. Comps.
3

This declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2015/863/EU.

EU ELV Directive: 2000/53/EC	Compliant with Exemptions 10(a) - Lead in certain electronic components.
China RoHS 2 Directive: MIIT Order No 32, 2016	Bestricted Materials Above Threshold
EU REACH Regulation: (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2023 (233) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content:	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability Code:	Reflow solder capable to 260°C

TE Connectivity Corporation

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This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Page 1 of 2



Restricted Materials Above Threshold

12 June 2023

25

中国电子电气产品中有害物质的名称及含量

China EEP Hazardous Substance Information

本表格依据SJ/T O: 表示该有害物 Indicates that	 (Pb) X 11364标准的规定 质在该部件所有均		镉 (Cd) O This table	ous Substance 六价铬 (Cr6) O is compiled acc	多溴联苯 (PBB) O	多溴二苯醚 (PBDE) O 11364 standard
电阻器和电感器 (Resistors and Inducto 本表格依据SJ/T O: 表示该有害物 Indicates that	(Pb) X rs) 11364标准的规定	(Hg) O 编制。	(Cd) O This table	(Cr6) O	(PBB) O	(PBDE) O
Resistors and Inducto 本表格依据SJ/T O: 表示该有害物 Indicates that	rs) 11364标准的规定	编制。	This table			
本表格依据SJ/T O: 表示该有害物 Indicates that	11364标准的规定			is compiled acc	cording to SJ/T	11364 standard
below the rele	the concentration	of the hazardo	ous substance			
Indicates that	质至少在该部件的 the concentration the relevant thresh	of the hazardo	ous substance	in at least one		

Page 2 of 2